# CPI1008KR47R-10

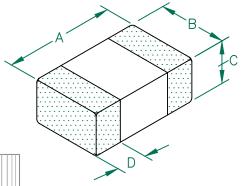
# PHYSICAL DIMENSIONS:

A 2.50 [.098] ± 0.20[.008]

B 2.00 [.079] ± 0.20[.008]

 $^{\circ}$  0.90 [.035]  $^{\pm}$  0.10[.004]

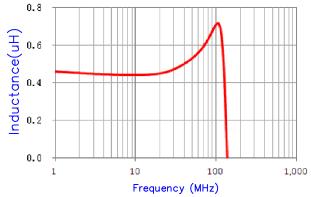
D 0.60 [.024] ± 0.20[.008]



# ELECTRICAL CHARACTERISTICS: L (μH) @ 1MHz DCR ( $\Omega$ ) I (Max) ± 20% Nom 0.470 Min 0.376 Max 0.564 0.0875 1800mA

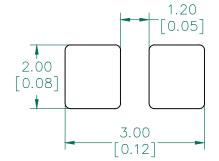
### NOTES: UNLESS OTHERWISE SPECIFIED

- TAPED AND REELED per CURRENT EIA SPECIFICATIONS
   REELS, 3000 PCS/REEL, EMBOSSED PLASTIC TAPE.
- 2. TERMINATION FINISH IS 100% MATTE Sn OVER Ni.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- I (MAX.) IS BASED ON THE MAXIMUM SUSTAINED CURRENT APPLIED WHILE MAINTAINING A MAXIMUM TEMPERATURE RISE OF 40°C OVER AMBIENT.
- 5. OPERATION TEMPERATURE TEMP: -55°C~+125°C (INCLUDING SELF-HEATING)
- 6. COSMETIC SPECIFICATION REFER TO WI-QA-124.



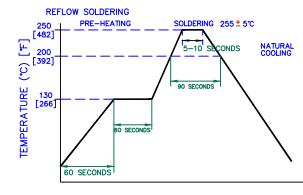
Ls vs Frequency

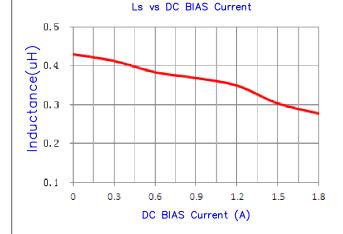
## LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763 [0.030] to this dimension)

### RECOMMENDED SOLDERING CONDITIONS







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ı					reserved.					
Ì	D	CHANGE DCR	07/13/17	QIU	PROJECT/PART NUMBER:	1	_	PART T		DRAWN BY:
Ì	С	UPDATE PAD DIMENSION ROHS	07/08/14	QU	CPI1008KR47R-10	1	D	CO-	-FIRE	QU
Ī	В	UPDATE LAIRD LOGO AND NOTES 5	08/05/13	QU	DATE: 03/01/11	SCAL	NIS		SHEET:	
ſ	Α	ORIGINAL DRAFT	03/01/11	QU	, ,	TOOL				
Ī	REV	DESCRIPTION	DATE	INT	CPI1008KR47R-10-D		•	-	1	of 1